BUILDING AUTOMATION
Leading-edge IoT solutions for HVAC, fire/safety, building security, and lighting
BUILDING AUTOMATION

BRINGING COMFORT, SAFETY, AND ENERGY SAVINGS TO PEOPLE, BUILDINGS, AND COMMUNITIES WITH SOLUTIONS TO CONNECT, PROTECT, AND CONSERVE

By connecting air conditioning, disaster prevention, crime prevention, and lighting equipment via networks, buildings can be made more convenient, secure, and energy efficient. Renesas leverages advanced technologies in connectivity, sensing, user interface, and low-power to enable the next generation of advancements in building automation.

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Building Automation Solution Devices and Platform

Renesas provides solutions for building systems (HVAC*, fire and safety, building security, and lighting). Each solution includes components such as devices, evaluation boards, development tools, and documentation to provide total support for customers’ development efforts.

The Renesas Synergy™ platform provides three types of value to developers of complex embedded systems in fields such as building automation: shorter development time, reduced total cost of ownership, and elimination of barriers to starting development.

* HVAC: Heating, Ventilation, and Air Conditioning

Web
Sensors in the Building Environment

Nowadays there are a variety of sensors at various locations throughout the interior of a typical building, and demand for such sensors is expected to increase. Here we highlight some of the locations and specific applications in which sensors from Renesas are used.

- **Cooling tower**: Temperature and humidity sensor, flow sensor
- **Thermostat**: Temperature and humidity sensor, air quality sensor
- **Chiller and boiler**: Flow sensors
- **FCU**: Fan control unit
- **VAV**: Variable air volume
- **AHU**: Air handling unit
- **Detector**: Gas sensor
- **FCU, VAV controller, ventilator**: Air speed sensors
- **AHU**: Temperature and humidity sensor, air speed sensor

### Features of Renesas Sensors

Renesas sensors include compact products offering superior sensitivity and accuracy. Evaluation boards are also available, making it easy to assess the performance of these products.

#### Temperature and Humidity Sensors

**Representative Product**

HS300x, HS310x

**Features**

- Wide measurement range (0% to 100% RH)
- High measurement accuracy (±1.5% RH, ±0.2°C)
- Compact package (3.0 × 2.4 × 0.8 mm)
- I2C interface for easy connections
- Available in a waterproof package with an IP67 rating

**Evaluation Board Product Name**

SDAH01, SDAH02

**Application Example**

Temperature and humidity measurement in HVAC systems and thermostats

#### Air Quality (Gas) Sensors

**Representative Products**

ZMOD4410, ZMOD4510

**Features**

- Detects total volatile organic compounds (TVOC). (Supports estimated carbon dioxide (eCO2) calculation.)
- Extensible via firmware updates.
- Supports IAQ-grade detection conforming to German Environment Agency (UBA) standards.
- Detects emissions of ozone and NOx (ZMOD4510 only).
- Available in a waterproof package with an IP67 rating

**Evaluation Board Product Name**

ZMOD4410-EVK

**Application Example**

Air quality measurement in thermostats
Flow Sensors (Liquid, Gas) and Airflow Sensors

Representative Products
FS2012, FS102x

Features
• Mass flow sensor module measures the flow
• Superior acid and alkali tolerance
• Vibration resistant
• High sensitivity

Evaluation Board Product Names
SDAF0x

Application Example
Liquid and air(gas) flow and airflow measurement in HVAC systems

Time of Flight (ToF) Signal Processing IC

Representative Products
ISL29501IRZ-T7, ISL29501RZ-T7A

Application Level Integrated
• On-chip Digital Signal Processor calculates the time of flight
• Built-in current DAC circuit that drives LED or laser
• On-chip active ambient light rejection

Easy Control
• I²C interface for configuration and control.
• Operates in Continuous and Single Shot mode
• Auto gain control mechanism
• Interrupt controller
• Modulation frequency of 4.5MHz

Suitable for Different Design
• Enables proximity detection and distance measurement
• Allows to optimize for performance/ power/ distance etc.
• Wavelength agnostic
• Emitter DAC with programmable current up to 255mA
• I²C interface supporting 1.8V and 3.3V bus
• Low profile 24 Ld 4 × 5 QFN package

Use in Conjunction with an MCU

Renesas offers MCU products that are the perfect match for sensors. By choosing an MCU with support for various communication interfaces, it is possible to transfer sensor data over a network. Example uses of sensors in conjunction with MCUs to implement building automation applications are presented here.

<table>
<thead>
<tr>
<th>Example</th>
<th>Sensors</th>
<th>Recommended MCUs</th>
</tr>
</thead>
<tbody>
<tr>
<td>Thermostat with wireless functionality</td>
<td>ZM0D4410 air quality sensor and HS3001 temperature and humidity sensor</td>
<td>RL78/G1H (sub-GHz RF), RA4W1, RX23W, RE01B, RL78/G1D (Bluetooth LE), and RX100 or RX200 Series (HMI)</td>
</tr>
<tr>
<td>HVAC refrigerant sensor</td>
<td>FS1012 flow sensor</td>
<td>RL78/G Series (system control)</td>
</tr>
<tr>
<td>Gas alarm</td>
<td>SGAS711 gas sensor</td>
<td>RL78/G12 (system control)</td>
</tr>
</tbody>
</table>

For the latest information on using sensors in conjunction with MCUs, visit the Winning Combinations webpage (https://www.renesas.com/us/en/solutions/idt.html).
HVAC building automation system can be divided into two types: central air conditioning and individual air conditioning.

**Central Air Conditioning System**

As illustrated in Figure 1, in a central air conditioning system a heat source in a single location is used to circulate air, water, or steam to the various rooms, and exchange heat, in order to cool or heat each room to the specified temperature. Water refrigerated by the chiller is pumped to the air handling units (AHUs) where heat exchange with the air takes place, producing cold air that passes through the ducts to cool the rooms. The cooling water gradually becomes warmer and is returned to the chiller, where it is refrigerated again. During this process the CFC refrigerant, etc., that acts as the heat medium evaporates and is sent to a compressor, where it is turned into a high-temperature, high-pressure gas. Cooling water is used to convert this gas into liquid form. After the cooling water undergoes heat exchange in a condenser, it is sent to the cooling towers on the roof, where it is cooled through contact with the air. Then it is returned to the chiller and the cycle is repeated.

The heat source (boiler) is powered by gas, oil, or electricity. It heats water in a vessel to produce hot water or steam. To heat the rooms, this hot water or steam is circulated through the rooms, and heat exchange takes place. Either a pair of two pipes or a set of four pipes can be used to circulate the cold or hot water. There are outgoing and incoming hot-water and cold-water pipes used to distribute the hot and cold water to air handling units (AHUs), fan coil units (FCUs), etc. In a two-pipe system the same pipes are used for both hot and cold water, switching from one to the other depending on the season and whether heating or cooling is required. This means heating and cooling operation cannot take place at the same time. On the other hand, if the cooling and heating coils built into the AHUs, FCUs, etc., are each equipped with their own outgoing and incoming pipes, simultaneous heating and cooling operation is possible within the same building. Such an arrangement is called a four-pipe system from the total number of pipes used. An outdoor-air processing unit (or total heat exchanger) extracts the heat or cold from indoor air that expelled to the outside (exhaust) and transfers it to fresh air from outside, thereby minimizing the difference in temperature between the indoor air and the fresh air from outside. ACU or air handling unit uses cold water, hot water, or steam supplied by the heat source unit to adjust the temperature and humidity of the air, which is then supplied to the rooms.

HVAC systems use air, water, or refrigerant as the medium for heat exchange. Some central air conditioning systems use a method called variable air volume (VAV), in which valves connected to the AHU are used to adjust the volume of cool (or warm) air passing through the ducts. In a water-cooled system cold or hot water is circulated via pipes, and FCUs perform heat exchange to adjust the temperature of each room.

![Figure 1 Central Air Conditioning System](image)
**Individual Air Conditioning System**

In an individual air conditioning system, refrigerant gas is circulated and exchanges heat. One typical example (Figure 2) is a building multiple air conditioner system. The temperature can be set for each room, and simultaneous heating and cooling operation are possible. Sometimes central air conditioning and individual air conditioning are used in combination, depending on the size of the building and its purpose.

**HVAC Motor Control**

Table 1 and Table 2 list the units requiring motor control that are used in the two types of air conditioning system. The use of inverters and brushless DC motors is increasing in variable speed motor control applications requiring energy efficiency. In addition, an individual indoor unit or outdoor unit may contain multiple motors requiring control. Renesas offers development kits for the control systems most appropriate for three motor types: induction motors, brushless DC motors, and stepping motors.

**HVAC Communication Network**

Regardless of the type of air conditioning system, generally speaking the various units are connected to a wired or wireless network to facilitate control and state management. In the context of building automation in particular, BACnet* is used to connect HVAC devices from different manufacturers and configure the building management system. Figure 3 shows conceptual diagrams of HVAC system communication in a central air conditioning system and an individual air conditioning system, respectively.

In the central air conditioning system, digital signals (DI and DO) and analog signals (4-20mA) are used for communication between sensors, VAV units, and general-purpose controllers. Due to the long distances involved and need for noise tolerance, Renesas offers communication solutions that employ power line communication (PLC).

**HVAC User Interface**

Some remote controllers for indoor unit temperature setting utilize screen-based interfaces. The recent trend is away from using conventional mechanical keys (mechanical switches) and toward the use of touch panels. These touch panels must be able to withstand demanding environmental conditions, including high noise levels, water, dirt, and temperature variations. Renesas offers HMI solutions that meet these challenges.

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* BACnet (Building Automation and Control Networking protocol) is an open protocol established in 1995 by the American Society of Heating, Refrigerating and Air-Conditioning Engineers (ASHRAE). In 2003 it was adopted as the international standard ISO 16484-5.
In the context of building automation, fire and safety systems are designed to detect the outbreak of fires and provide warning, for example by sounding alarm bells throughout the building. An automatic fire alarm system for buildings has a receiver that detects when one of the sensors connected by wires is triggered by a fire. The system then alerts the building occupants by sounding alarm bells or voice alarms throughout the building. Fire alarms used in buildings and in homes employ the same sensing methods, but they differ in that building systems are connected to networks while home systems are independent and sound the alarm individually. Figure 1 illustrates examples of sensing and notification types.

**Automatic Fire Alarm Systems**

An automatic fire alarm system comprises a receiver, automatic sensors, manual transmitters, sound devices, fire doors, fire shutters, smoke shutters, and network devices to which they are connected. The receiver is installed in a fire protection center or management office within the building. It receives signals from the sensors if a fire breaks out, and controls such things as the display of indications of where the outbreak occurred and the sounding of audible alarms such as bells or voice messages. The receiver also supplies power to the system as a whole. It normally operates on the AC 100V power supply, but it is equipped with a backup power supply in case of a power failure. Figure 2 shows an example type-R receiver and peripheral system. The receiver is connected to automatic sensors, alarms, etc., via a relay, or it may be connected to the building’s central monitoring system.

The automatic sensors are installed in the various alarm zones throughout the building. They automatically detect the outbreak of fire from the heat, smoke, or flame, and send a signal to the receiver. Figure 3 shows a photoelectric spot sensor for detecting smoke. When smoke enters the sensor, the light emitted by the emitter (LED) is diffused by the smoke particles, and this is detected by the receiver.

The sound devices are installed in various locations throughout the building. These emergency alarm units sound a bell or a voice warning when they receive a signal from the receiver. Each of these devices is connected to the network via a wired or wireless communication system. Wired networks use the RS-485 data transfer standard over dedicated wires, and wireless networks use the 426MHz band, BLE, or Sub-GHz band, among others.

Renesas offers the following solutions for fire and safety systems.

**Controllers for Detection and Communication**

**Recommended devices**
- RL78/I1D and RL78/G11: analog function (amp, CMP), low power consumption
- RL78/G10, RL78/G12, and RL78/G13: general-purpose MCUs with low power consumption
- RL78/G1H and RL78/G1D: RF communication
- R9A06G037 and R9A06G061: NB-PLC communication

**Analog Products**

**Recommended devices**
- SGAS7xx Series gas sensors
- RAA211605 or ISL85415 step-down regulator
- ISL9123 ultra-Low Iq buck regulator
- ISL9122A ultra-Low Iq buck-boost regulator
In the context of building automation, a security system is composed of two constituent elements. Figure 4 is a conceptual diagram. The first is a monitoring system that oversees what is going on in and around the building by means of cameras and sensors of various types. The second is a crime prevention system that performs ingress and egress management and control based on the information from the monitoring systems.

**Monitoring Systems**

Monitoring systems may include motion sensors for ingress monitoring and fire detectors, carbon monoxide detectors, and the like to monitor for emergencies within the building (Figure 5). The monitored information is sent via the network to a supervisor in the form of emergency signals and images. This information can also be stored and managed on a security data server, if needed.

**Crime Prevention Systems**

Crime prevention systems may incorporate sensors such as door open-close detectors and glass break detectors to detect emergencies as well as ingress and egress management functions to enforce entrance and exit regulations and keep logs of those entering and leaving. They control the entrance and exit of persons to and from the building in conjunction with the information from the monitoring systems (Figure 5).

**Communication Networks of Security Systems**

Via the network, the large volumes of data making up the security logs, operation logs, and entrance and exit logs from the monitoring and crime prevention systems are tracked on security monitoring PCs and stored and managed on security data servers. This information may also be linked via a network to other building automation systems (air conditioning systems, lighting systems, etc.) to enable more efficient building security management.

Renesas offers the following solutions for building security applications and provides support to developers as well.

**Sensing (Sensors for Monitoring and Crime Prevention)**

Motion detectors / Smoke detectors / Carbon monoxide detectors / Glass break detectors

**Connectivity (Networks Linking Units and Systems)**

Power line communication (PLC) / Bluetooth low energy (BLE) / Sub-GHz

**HMI (Ingress and Egress Management)**

Human-machine interface (HMI) / Capacitive touch keys
Control devices. This means that a variety of lighting products can be developed on a shared foundation. A second feature is that DALI is an open standard. Products from different manufacturers can connect to each other, to adjust the brightness and color for example. Thus, it is possible to centrally manage the entire lighting system and implement control in a way that saves energy. DALI lets users maximize the energy efficiency of the building’s lighting system.

Advancing to DALI-2

A new DALI standard, DALI-2, is currently coming into use. DALI-2 defines new applications, adds new functions, and improves compatibility to better meet the lighting requirements of customers. Also, a device must pass an official test to receive certification of compliance with the standard. Renesas was the first semiconductor device manufacturer to join the DALI standardization organization. This enables us to deliver solutions that track the latest trends in the standard and include a tested protocol stack by official DALI tester.

Implementing Task/Ambient Lighting with DALI

“Task/ambient lighting” means that different types of lighting are used for “tasks” such as desks and for “ambient” areas such as floors and corridors. Some features of task/ambient lighting are that it can boost work efficiency by allowing adjustment of the brightness and hue to match individual preferences, and that it can boost energy efficiency by providing only the amount of light needed in each location.

Further energy savings can be achieved by, for example, using motion sensors to detect when people are around, allowing the lights to be extinguished automatically when not needed, or using light sensors to detect light from outside, which can be taken into account when controlling brightness. Figure 3 shows an example of task/ambient lighting using DALI.

This task/ambient lighting configuration allows individual control of the lighting of task areas such as desks and of ambient areas such as floors and corridors. The lighting fixtures, sensors, and switches are all connected via DALI, and alternatively a unit such as a lighting controller can be used to provide centralized management. In this way DALI can be used to link and control all essential devices, making it easy to implement task/ambient lighting.
Digital Power Supplies for Lighting Fixtures

LED lighting product development cycles are growing shorter due to efforts to respond to new market needs. In particular, development of the power supply block, where several functions are concentrated, is a key point. One way to make development more efficient is to digitize the power supply. Digital power supplies provide three major features.

• **Fewer Components**

  Since software can be used to tune the performance of a digital power supply, there is no need for the hardware tuning components previously required. In addition, MCUs designed for digital power supplies integrate essential peripheral functions on-chip, so the cost of external IC devices is greatly reduced.

  ![Figure 4: MCU for Digital Power Supplies (RL78/I1A)]

• **Shorter Development Time**

  It is possible to modify the operation of a digital power supply simply by making changes to the software (parameters). This means that creating a platform based on a common board and software makes it easy to derive new products from existing ones. In addition, there is a high affinity with communication functions, making it possible to develop DALI-conformant products that match market needs in a short period of time.

  ![Figure 5: Reduction in Development Time with Digital Power Supply]

• **Improved Power Supply Performance**

  When a sudden change in load occurs, it is possible to keep the output variation smaller with a digital configuration than with an analog one. This means that there is no longer any need for capacitors to suppress LED flicker when dimming the brightness or as a countermeasure for ripple currents. In addition, digital power supply technologies such as variable gain and auto-tuning can be used to increase responsiveness, maintain stability, and suppress variability in ways that are not possible using analog devices.

  ![Figure 6: Example of Performance Boost by Digitizing the Power Supply]

Renesas Solutions

Renesas offers many solutions that provide powerful support for customers’ product development efforts in areas such as networking and digital power supplies.

![Figure 7: Renesas Lighting Solutions]

In particular, the DALI protocol stack consists of elements that have already been tested by official DALI tester. These solutions allow customers to focus their development work on functions and products that provide added value. For details, refer to the lighting solutions on page 18. Also make sure to look into the following types of solutions, which can be applied to lighting applications as well.

• HMI solutions (page 13)
• Connectivity solutions (page 14)
• Sensing solutions (page 16)
MOTOR CONTROL SOLUTIONS

Renesas motor control solutions aim to make buildings more efficient by reducing the power consumption of motors. A number of motor control methods are used to accommodate various product applications, and each poses its own difficulties during development. Renesas offers motor control solutions for brushless DC motors. They include environments for experimenting with 120-degree conduction control and vector control with brushless DC motors. A wide variety of sample programs, documentation, and development support tools are available, providing total support for customers’ development efforts.

Brushless DC Motor Control Solution

Outline
This solution supports multiple control methods for driving brushless DC motors and includes hardware, control software, and development support tools. It provides an easier way to evaluate sensorless vector control, which enables motor drive with high efficiency and at low cost.

Configuration
- Permanent magnet synchronous motor (brushless DC motor)
- Three-shunt current detection function
- Overcurrent protection function
- With optional CPU cards (sold separately), various motor control MCUs can be evaluated.
- Compatible with higher voltage and current than conventional kits (48V / 5A)
- Compatible with existing CPU cards
- Supports the Renesas Motor Workbench development support tool.
  - Automatic tuning function for vector control (Tuner)
  - Debugging functions optimized for motor control (Analyzer)

Available Software

<table>
<thead>
<tr>
<th>Sample Software</th>
<th>Supported MCUs</th>
</tr>
</thead>
<tbody>
<tr>
<td>120-degree conducting control + Speed control (Hall, Sensorless)</td>
<td>RX23T, RX24T</td>
</tr>
<tr>
<td>Vector control + Speed control (Encoder, Sensorless)</td>
<td>RX13T™, RX23T, RX24T, RX24U, RX66T, RX72T, R4T1</td>
</tr>
<tr>
<td>Vector control + Position control (Encoder)</td>
<td>RX23T, RX24T, RX24U, RX66T, RX72T, R4T1</td>
</tr>
</tbody>
</table>

*1: Sensorless only.

Evaluation System for BLDC Motor
- 48V inverter board
- Permanent magnet synchronous motor
- Cables
- This solution kit does not include a CPU card. Please purchase the desired CPU card before use.

Renesas Motor Workbench
- Automatic tuning function for vector control (Tuner)
- Debugging functions optimized for motor control (Analyzer)

Applications
- Brushless DC motor control for fans, pumps, compressors, etc., in HVAC units.

Renesas Solutions for Different Motor Types and Control Methods
Renesas offers kits and motor control software to match various motor types and control MCUs. Each kit comes with different sample software, so refer to the table below to select the appropriate solution to meet your requirements.

<table>
<thead>
<tr>
<th>Distribution Format</th>
<th>Motor Type</th>
<th>Name of Kit</th>
<th>Sensorless</th>
<th>Vector Control</th>
<th>120-Degree Conducting Control</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td>Speed Control</td>
<td>Speed Control</td>
<td>Speed Control</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>Speed Control</td>
<td>Positioning Control</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>Speed Control</td>
<td>Positioning Control</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Sensorless</td>
<td></td>
<td>Hall Effect</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>Vector Control</td>
<td>Speed Control</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>Speed Control</td>
</tr>
<tr>
<td>Supplied as complete kit by Renesas</td>
<td>BLDC</td>
<td>Evaluation system for BLDC Motor + CPU Card HTK0EMX27050020BJ</td>
<td>✓</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td></td>
<td>Stepping</td>
<td>Evaluation System for Stepping Motor with Resolver HTK0EMX270501020BJ</td>
<td>—</td>
<td>—</td>
<td>✓</td>
</tr>
<tr>
<td>Supplied as complete kit by Renesas</td>
<td>BLDC</td>
<td>Evaluation system for BLDC Motor + CPU Card HTK0EMX27050020BJ</td>
<td>—</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>Renesas kit + motor with encoder*2</td>
<td>BLDC</td>
<td>Evaluation system for BLDC Motor + CPU Card HTK0EMX27050020BJ</td>
<td>—</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>Supplied as sample software and application note by Renesas</td>
<td>Induction motor</td>
<td>Evaluation system for ACIM</td>
<td>✓</td>
<td>—</td>
<td>—</td>
</tr>
</tbody>
</table>

*1. The customer must supply a motor with an optical encoder.
*2. Magnetic encoder also supported. (The customer must supply a motor with a magnetic encoder.)
*3. The customer must supply an induction motor and inverter board.

https://www.renesas.com/application/home-building/motor-control-solutions
USER INTERFACE SOLUTIONS

Renesas HMI solutions comprise microcontrollers incorporating exclusive touch panel sensing technology and a custom development environment that facilitates quick development of high-grade products. There are also solutions that can be used to boost legibility and ease of use with interfaces supporting video and 3D-graphics. These solutions support the efforts of customers to develop systems providing high affinity between human and machine and allow users to make the most of the functions they offer. AE-CAP1, with support for capacitive touch, and PE-HMI1, with support for HMI, are available as solutions through the Renesas Synergy™ Platform. For details, refer to Renesas Synergy™ Platform Solutions on page 22.

Capacitive Touch Sensor Solutions

Outline
Capacitive Touch Sensor solution can develop product interfaces operated by touching the panels with a finger instead of conventional mechanical switches. With the capacitive touch sensor can realize intuitive user interface and excellent design.

Configuration
- Capacitive Touch Evaluation System:
  Using the board, software and development tool included in the evaluation system, you can get started with evaluation right away.

- Capacitive Touch Development Tool QE for Capacitive Touch:
  QE for Capacitive Touch makes it easy to adjust the sensitivity of the touch buttons, shortening time to market.

Applications
For use in the HMI block of HVAC, fire and safety, building security, or lighting systems.

HMI Solutions

Outline
These human-machine interface solutions incorporate RZ/G2 microcontrollers and enable customers to create new value through sensing. Designed for use in system evaluation and development, they support multi-plane video processing, 3D graphics, and a variety of high-speed interfaces.

Configuration
- The RZ/G2 evaluation boards each support a Verified Linux Package (VLP).
- The VLP utilizes an industrial grade Linux Civil Infrastructure Platform (CIP) providing 10 years or more of long-term support.
- The product package includes middleware that has been verified on the evaluation board. This enables customers to develop applications in a stable operating environment.

Applications
For use in the HMI block of HVAC, fire and safety, building security, or lighting systems.

Capacitive Touch Evaluation System

Supported MCU:
RL78/G23, RA2L1, RA6M2, RX130, RX140, RX671, Renesas Synergy™ S124, Renesas Synergy™ S3A7

Capacitive Touch Development Tool QE for Capacitive Touch

Main/Sensor Tuner View

Board Monitor View

Status Chart View

Veriﬁed Linux Package (VLP)

*1. RZ/G Reference Board is used for Kernel development as a software development platform for CIP projects.
CONNECTIVITY SOLUTIONS

Renesas connectivity solutions are available for wireless communication (BLE and Sub-GHz) and wired communication (PLC) applications. They enable customers to build networks linking devices and systems without the need to install new wiring.
Evaluation boards, sample software, evaluation tools, and documentation are provided to provide total support for customers’ development efforts.

**Bluetooth Low Energy Solution**

**Outline**
Bluetooth® Low Energy enables low-power data link with devices including smartphones. Bluetooth LE is supported in a wide range of Renesas MCUs such as RA4W1, RX23W, RE01B and RL78/G1D. Customers can use the evaluation board to develop new Bluetooth LE applications.

**Configuration**
- Evaluation board and Bluetooth LE control (GUI) Tool
  - Bluetooth LE protocol stack
  - QE for BLE — Development Assistance Tool
  - GATTBrowser — iOS/Android Application for operation confirmation

Added Dialog SmartBond™ products. For more details, please visit: https://www.renesas.com/solutions/bluetooth

**RS-485 Communication Solution**

**Outline**
RS-485 uses differential signaling to enable long-distance data transfer, even under noisy conditions. It also aims to improve and extend the functionality of the earlier RS-422 standard. With RS-485 up to 31 devices can share a single data line. Any slave device on the RS-485 bus can communicate with the other 31 devices without the need to connect via a master device.

**Features of Renesas Products**
- Extensive product lineup to meet an array of system requirements
- High-speed communication support (up to 100Mbps)
  - PROFIBUS® support
  - Isolated products
  - Operation at 125°C
- Highest level of noise tolerance and ESD protection

**Product Examples**
- High speed (RS-485)
  ISL3159E: PROFIBUS support, high-speed (40Mbps), operation at 125°C
  ISL3259E: Ultra-high speed (100Mbps)

**Sub-GHz (920MHz) Wireless Solution**

**Outline**
Provides support for the Wi-SUN for FAN Profile, an international wireless communication standard established by the Wi-SUN Alliance. Wi-SUN FAN enables us to control various infrastructures such as sensing, lighting and building automation remotely by building a large-scale mesh network.

**Configuration**
- RL78/G1H evaluation board as low-power solution
- RX651 + RAA604S00 evaluation board as advanced functionality solution
- Both products include RF driver/MAC stack, IP stack, and RF characteristics evaluation program.

**Applications**
Used for induction motor control for fans, pumps, compressors, etc., in HVAC units.
Power Line Communication (PLC) Solutions

PLC Solutions

PLC is a technology that uses existing power lines as the communication medium. Using the power grid as a communication network makes it possible to build out systems cheaply and quickly. Either AC power lines or DC power lines can be employed as the communication medium.

Renesas offers narrowband PLC modem IC products with integrated CPUs that implement high-performance DSP and support a variety of power line communication protocols. They employ orthogonal frequency-division multiplexing (OFDM) to deliver highly reliable, robust communication. Renesas PLC modem ICs support high data transfer speeds up to 1Mbps over long distances of a kilometer or more.

Example of PLC Communication Module Configuration for AC Power Lines

Example of PLC Communication Module Configuration for DC Power Lines

Evaluation Environment

Multiple types of evaluation kits optimized for AC power lines or DC power lines are available for R9A06G061/R9A06G037 evaluation and development work. Circuit diagrams, parts lists, and Gerber data are available for each evaluation kit.

PLC-RF Hybrid Solution

Renesas offers a PLC-RF hybrid solution that combines a PLC solution and a Sub-GHz wireless communication solution. The PLC-RF hybrid solution provides Sub-GHz wireless communication coverage in areas where communication cannot be implemented using PLC alone, thereby enhancing network reliability and expandability. The PLC-RF hybrid solution brings together two different communication technologies in a way that makes it easy for users to make use of them as a single network.

PLC-RF Hybrid Evaluation Board

This evaluation board implements the Renesas PLC-RF hybrid solution. It is populated with the R9A06G037 as the PLC modem IC and the RAA604S00 as the wireless communication IC. The evaluation board supports two major communication protocols, G3-PLC Hybrid and PRIME Hybrid, making it suitable for a broad range of applications.

Voice Communication Solution

A RX651 library is provided to enable use of the R9A06G037 PLC modem chip to realize a voice communication solution. Voice data can be encoded and decoded, and sent and received over power lines via the R9A06G037. The J80D1 evaluation kit is supported. In addition, a GUI tool can be used to easily control and check the status of voice communications.

Evaluation Environment

Multiple types of evaluation kits optimized for AC power lines or DC power lines are available for R9A06G061/R9A06G037 evaluation and development work. Circuit diagrams, parts lists, and Gerber data are available for each evaluation kit.

PLC-RF Hybrid Evaluation Board

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Voice Communication Solution

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SENSING SOLUTIONS

These solutions are suitable for building security systems and deliver low cost and power efficiency alongside highly accurate measurement. Using these reference boards contributes to significantly shorter development time. The core devices of these solutions are RL78/I1x microcontrollers. They combine the exclusive architecture and superior power performance of the RL78 Family of microcontrollers with analog functions ideal for sensing applications. For details, visit the RL78/I1x Series page on the Renesas website.

**Glass Break Detector Solution**

**RL78/I1D Detect it!**

**Outline/Features**

This solution uses a microphone to detect when the glass is broken. Active filtering for the microphone is implemented using the microcontroller’s on-chip low-power op-amp. Reduces costs while achieving extended operation on battery power.

**Configuration**

- Microcontroller: RL78/I1D low-power analog microcontroller
- Solution board: RL78/I1D Detect it! glass break detector board

Circuit diagrams, parts lists, and sample programs are available.

**Applications**

Crime prevention products

**Smoke Detector Solution**

**RL78/I1D Detect it!**

**Outline/Features**

This solution uses an infrared LED and an optical receiver to detect the presence of smoke. The low-power RL78/I1D with on-chip sensor amplifier helps reduce system cost while achieving extended operation on battery power.

**Configuration**

- Microcontroller: RL78/I1D low-power microcontroller
- Solution board: RL78/I1D Detect it! smoke detector board

Circuit diagrams, parts lists, and sample programs are available.

**Applications**

Sensors, alarms

**Carbon Monoxide Detector Solutions**

1) **RL78/I1D Detect it!**

**Outline/Features**

This sensing solution uses a carbon monoxide canister. It enables detection of carbon monoxide at concentrations of 100ppm ±10ppm.

**Configuration**

- Microcontroller: RL78/I1D low-power analog microcontroller
- Solution board: RL78/I1D Detect it! carbon monoxide detector board

Circuit diagrams, parts lists, and sample programs are available.

**Applications**

Carbon monoxide warning systems, carbon monoxide detectors

2) **RL78 Quick Solution**

**Outline/Features**

This is a reference design for a carbon monoxide alarm for home use. The output of a carbon monoxide canister is amplified by the ISL28113 op-amp, and A/D conversion is performed on the compact, low-pin-count RL78/G10 MCU to determine the concentration of carbon monoxide.

**Configuration**

- Microcontroller: Compact, low-pin-count RL78/G10 MCU
- Op-amp: ISL28113

**Applications**

Carbon monoxide alarm for home use
**Motion Sensor Solutions**

1) RL78/I1D Detect it!

**Outline/Features**
This solution uses pyroelectric motion sensors to detect the movement of persons. Two sensors are used to allow detection of the direction of movement. The microcontroller’s on-chip low-power op-amp reduces the system cost.

**Configuration**
- Microcontroller: RL78/I1D low-power analog microcontroller
- Solution board: RL78/I1D Detect it! motion detector board
  Circuit diagrams, parts lists, and sample programs are available.

**Applications**
- Crime prevention units, lighting systems

2) RL78 Quick Solution

**Outline/Features**
This Infrared Human Sensor reference design detects human presence/absence using an infrared sensor, and turns on/off a high brightness LED automatically. It can be applied to a wide range of applications including office lights and automatic doors.

**Configuration**
- User’s manual, source code, circuit diagram, PCB, and BOM are available.

**Applications**
- Crime prevention units, lighting systems

---

**Portable PM2.5 Measuring Device Solution**

**RL78 Quick Solution**

**Outline/Features**
This portable measuring device detects and measures the concentration of PM2.5 in the air in real time. The air quality is indicated by the color of an LED (red, green, or blue) and an LCD panel. The system also provides charging and power supply functionality as a mobile battery, and displays the battery capacity using LEDs. If the PM2.5 concentration exceeds a preset threshold or the battery voltage drops below 2.8V, a buzzer sounds.

This solution utilizes the I/O port, A/D converter, buzzer, LCD controller, and STOP mode functions of the RL78/L12, a microcontroller ideally suited for small home appliances. In addition, ISL97656 (DC-DC converter chip) or ISL9122A (ultra-low Iq buck-boost regulator) controls battery discharge and the ISL6294 (battery charger chip) controls charging. The threshold value and PM2.5 concentration data are saved in EEPROM. (If there is less than 2KB of data, it can be stored in the on-chip data flash of the RL78/L12.)

**Configuration**
- User’s manual, source code, circuit diagram, PCB, and BOM are available.

**Applications**
- Air conditioner systems

**About RL78 Quick Solution**

RL78 Quick Solution is a convenient solution you can use right away for product development.

Items available for download:
- User’s manual
- Sample software source code
- Circuit diagram
- PCB layout data, BOM
Renesas + Dialog complementary product portfolios of Analog + Power + Embedded Processing + Connectivity work together to deliver comprehensive solutions.

### Voice/Face Recognition for Security Systems

Security systems continue to evolve to provide secure access to individuals based on biometric feedback. This solution utilizes a combination of voice and facial recognition to provide authorized entry.

**System Benefits**
- Soft error-free MCU with ECC function for all memory interfaces
- Turnkey solution on hardware with power and timing devices
- Embedded 3D graphic acceleration for high-speed processing

### Voice Activated DALI Lighting Controls

Digital addressable lighting interface (DALI) is a dedicated lighting control protocol for intelligent lighting systems that is widely used in commercial lighting control and building lighting control.

**System Benefits**
- The RL78/I1A is a one-chip solution for DALI/DMX512 and PWM dimming controls
- Voice module supports multi-national offline voice control
- Supports Time of Flight (ToF) distance detection
- Includes an OB1203 fully integrated optical sensing module to support RGB sensor function and biosense
- High-performance AC/DC and DC/DC for lighting

**Target Applications**
- Commercial lighting
- DALI-2 systems
- Building automation
Air Quality Control for IoT Building Automation

The ZMOD4410 gas sensor and HS300x humidity sensor family along with the RL78/G14 microcontroller enable users to sense the environment for gases, measure and improve air quality, and provide observations of goods during transport. The solution meets strict air quality regulations, saves energy, and helps maintain the user’s health and wellness.

Key Features
- Easy and fast integration into existing systems
- Fast productization
- Gas sensor with highest sensitivity to gases in the market
- Firmware upgradeable solution to meet specific customer needs and requirements

Target Applications
- Factory automation
- Building automation

Household Smoke Detector

The highly integrated RAA239101 low-power analog front-end IC includes all necessary peripherals and features required for a complete smoke detector system based on photoelectric detection principle. It enables a very flexible implementation with parametrization capabilities (LED-current selection, PGA gain setting, integrated battery test feature).

System Benefits
- Low-power analog front-end includes all necessary peripherals for a photoelectric smoke detector
- Ultra-low current consumption enables 10y+ battery lifetime
- Very few external components needed with a cost-optimized bill-of-materials (BOM) and small solution size vs. a discrete design
- Highly integrated analog front-end (AFE) allows the use of two different IR wavelength diodes/photodetectors (enhanced accuracy, UL217 compliant)
- Utilizes the small pin-count and low cost RL78/G12 MCU with DataFlash, enabling non-volatile data storage for alarm counter, operating hours, etc.
- AC mains power supply with small-sized and low quiescent current (IQ) AC/DC buck regulator (optional)

Target Applications
- Residential smoke detectors based on photoelectric principle
The demand for smart locks is a rapidly growing segment for the home and building automation industries. These locks need to be able to communicate with a smart home or building via fingerprint recognition and/or with a mobile phone using a common wireless communication protocol such as Bluetooth® or Wi-Fi. This smart lock solution features fingerprint control, low power Bluetooth and low power Wi-Fi options. The DA16600 low power Wi-Fi plus low power Bluetooth Low Energy (LE) module, DA16200 low power Wi-Fi networking system-on-chip (SoC) and DA14531 SmartBond TINY™ Bluetooth LE module provide the smallest and lowest Bluetooth 5.1, ultra-low power Wi-Fi SoC for battery-powered Internet of Things (IoT) devices. Additionally, the GreenPAK™ family of cost-effective NVM programmable devices provides features such as motor driver and LED control. And, the RX651 high-performance, low pin count, 32-bit microcontroller (MCU) is available to design in a fingerprint module for the algorithm design. A wide input range ultra-low quiescent current LDO and Time of Flight (ToF) sensor are also used for a complete compact design.

System Benefits
- Includes the world’s smallest and lowest power Bluetooth 5.1 system-on-chip
- Ultra-low power Wi-Fi SoC for battery-powered IoT devices
- High-performance 120MHz low pin count MCU for adding a fingerprint module
- Programmable mixed-signal matrix enables innovators to integrate many system functions into a single custom circuit

Target Applications
- Smart homes
- Smart buildings

Bluetooth Low Energy (BLE) Sensor Network Solution

This reference design provides the wireless sensor network solution to make indoor environments comfortable and healthy when using an HVAC system. It monitors temperature/humidity/indoor air quality (IAQ) data from each sensor using Bluetooth® 5.0 Low Energy.

System Benefits
- Bluetooth 5.0 Low Energy networking with the power efficient RA4W1 microcontroller.
- HS3001/HS3101 (with hydrophobic membrane to protect from dust and water) measures humidity and temperature.
- ZMOD4410 measures IAQ.
- The slave side monitors autonomously and sends out an alert, if necessary, eliminating the need for frequent inquiries to the master side.
- Customer can develop HVAC control algorithms based on alerts from the slave side.
- Wireless sensors are used to reduce the initiate set-up cost.
- Free GUI is provided that is suitable for demo, design, manufacturing, installation, and operation.

Target Applications
- HVAC for buildings, industry or homes
**Touchless Button Solution**

A touchless button solution can be widely used in homes (lighting switches, bathroom switches, etc.) and public locations (vending machines, electric door openers, etc.). A touch can be detected without directly touching the button; therefore, the adhesion of bacteria and dirt to the fingers is reduced. The touchless button solution lessens concerns over contaminated surfaces.

**System Benefits**
- Entry-level RA 32-bit MCU with a Capacitive Touch Sensor Unit 2 (CTSU2) provides touchless control with high sensitivity and high noise immunity. All Renesas MCUs that contain a CTSU are also compatible.
- Ultra-low Iq buck-boost can fully extract the power of a battery as low as 1.8V.
- Output voltage can be adjusted by the I2C bus.

**Target Applications**
- Elevators, vending machines, ticket selling machines
- Toilet flushing, water faucets
- Automatic door buttons
- Kitchen appliances: Refrigerators, microwave ovens, range hoods, etc.

For more Winning Combinations, please visit: [https://www.renesas.com/application/winning-combinations](https://www.renesas.com/application/winning-combinations)
Renesas lighting solutions provide powerful support for your development efforts. They make it possible to develop lighting applications in a short period of time in response to market demand for functionality such as network connectivity, digital power supply, and brightness or color adjustment. These solutions consist of an LED lighting evaluation environment, software development environment, communication evaluation environment, and application notes containing detailed information on how to use them.

**LED Lighting Evaluation Environments and Communication Evaluation Environments**

LED lighting evaluation environments consist mainly of reference solutions for developers of LED lighting fixtures. Several evaluation boards with different topologies and dimmer interfaces including DALI are available for a variety of customer applications. All boards support digital power supplies. Communication evaluation environments provide reference solutions for developers of products such as dimmers with communication capabilities (communication masters, DALI switches, sensors). They can be used to evaluate communication with lighting fixtures. Visit the Renesas website for details of each board.
Software Development Environment

Applet EZ for HCD
This tool can be used to create sample code for LED lighting and communication software and to program this software to hardware. Simply specify dimmer operations or communication modes in the GUI to generate digital power control (PFC, DC/DC) or DALI/DMX512 communication software code. The software created in this way can then be programmed automatically to the MCU’s flash memory via a USB cable so that you can check its operation on the evaluation board. This tool is available for download free of charge on the Renesas website.

Features
- Dramatically reduces the workload required to develop and evaluate LED control and communication software.
- Allows evaluation of LED lighting or illumination systems without requiring an extensive knowledge of MCUs and MCU environments.
- Generated program code can be edited in an integrated development environment (IDE).

DALI Protocol Stack Library
Renesas is a member of the Digital Illumination Interface Alliance (DiiA). We have offered MCU products, evaluation boards, and protocol stacks supporting the DALI interface for over a decade, and a large number of customers in many countries have adopted these products. DALI protocol stack components from Renesas have been tested\(^1\) by official DALI tester, who must all be members of the DiiA, so customers can use them with confidence. A number of library versions have also been developed by partner vendors working closely with Renesas. Moving forward, Renesas is committed to fostering the widespread adoption of DALI by supporting the development work of customers in collaboration with our partner vendors.

Features
- Tested by official testers.\(^*\)
- Versions are available to match specific MCU products.
- Substantially reduces the workload and time associated with development.
- Application notes providing a basic understanding of DALI are available.

### Protocol Stack Library Versions (As of December 2021)

<table>
<thead>
<tr>
<th>IEC62386 Standard</th>
<th>Application</th>
<th>Details</th>
<th>RL78</th>
<th>RX65N</th>
<th>Synergy(^*)</th>
<th>RA(^*)</th>
</tr>
</thead>
<tbody>
<tr>
<td>102</td>
<td>Lighting fixtures, PWM converters etc.</td>
<td>Control gear (General requirements)</td>
<td>✓</td>
<td>—</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>207</td>
<td></td>
<td>LED modules (Particular requirements)</td>
<td>✓</td>
<td>—</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td>209</td>
<td></td>
<td>Color modules (Particular requirements)</td>
<td>Under development</td>
<td>—</td>
<td>—</td>
<td>✓</td>
</tr>
<tr>
<td>103</td>
<td>Switches, sensors, routers etc.</td>
<td>Control devices (General requirements)</td>
<td>✓(^<em>) ✓(^</em>)</td>
<td>—</td>
<td>✓</td>
<td>—</td>
</tr>
<tr>
<td>301</td>
<td></td>
<td>Pushbuttons (Particular requirements)</td>
<td>Under development ✓(^<em>) ✓(^</em>)</td>
<td>—</td>
<td>✓</td>
<td>—</td>
</tr>
</tbody>
</table>

\(^1\) Official testers and test sequences are used to confirm the operation of the communication components of DALI products.

\(^2\) MBS/CS-Lab GMBH

\(^3\) A simplified version has been released by Renesas. A version for input devices is under development.

\(^4\) The stack for input device.

\(^5\) The stack for application controller.

\(^6\) Tessera Technology Inc.
An array of power management solutions suitable for various systems and devices.

Renesas offers an extensive product lineup as high-performance power supply solutions for system processors, controllers, DSPs, FPGAs, CPLDs, DDR memory, and other loads. Such Renesas products include general-purpose linear regulators, highly flexible PWM controllers and regulators, and fully integrated power modules, each of which is designed to meet a particular need that arises during power supply development.
**Analog Controllers**

**Advantages and Main Features**

**Stability and high performance**
- Wide range of protection functions (OCP, OVP, OTP, SCP)
- Pre-bias startup, external compensation

**Extensive product lineup**
- Wide input voltage range up to 72V
- Multiple settings possible (single-output, multi-output, multi-phase)
- Wide frequency range: 100kHz to 2.5MHz
- Many package options (DFN, QFN, HTSSOP, QSOP, etc.)

**High degree of integration**
- On-chip MOSFET driver
- On-chip bootstrap diode
- Internal compensation

**Target applications**
- POL converters for servers and infrastructure
- Industrial PCs, factory automation, PLC
- General-purpose POL converters
- Communication and networking systems

---

**Switching Regulators**

**Advantages and Main Features**

**Stability and high performance**
- Power-good, enable, variable software start
- Wide range of protection functions (OCP, OVP, OTP, SCP)
- External frequency synchronization

**High degree of integration**
- On-chip HS/LS FET
- Internal compensation

**Target applications**
- POL converters for servers and infrastructure
- Industrial PCs, factory automation, PLC
- General-purpose POL converters
- Communication and networking systems

---

**Power Modules**

**Advantages and Main Features**

**Superior ease of use**
- Completely integrated design that reduces complexity and simplifies design

**High power density**
- Ability to realize up to 40A output in a single package

---

**Heat-resistant package technology**
- Use of thermoplastic compounds for more efficient heat dispersion
- Large copper pads to improve thermal efficiency
- Full-load operation over wide temperature range
- Pin access via lead package

---

**Renesas power modules**

<table>
<thead>
<tr>
<th>Component</th>
<th>Specification</th>
</tr>
</thead>
<tbody>
<tr>
<td>PWM controller</td>
<td>40V to 36V</td>
</tr>
<tr>
<td>MOSFET</td>
<td>Max. 60V RAA2116xx</td>
</tr>
<tr>
<td>Inductor</td>
<td>Max. 42V ISL854xx</td>
</tr>
<tr>
<td>Compensation</td>
<td>4.5V to 28V ISL85033</td>
</tr>
<tr>
<td>Power rail</td>
<td>2.5V to 5.5V ISL80xxx</td>
</tr>
<tr>
<td>Power rail</td>
<td>0.6V to 3.3V POL power supply</td>
</tr>
</tbody>
</table>

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**Not heat sink, no airflow**
Direct heat transfer via copper lead frame
Renesas Synergy™ Platform Solutions for the Building Automation Market

Renesas Synergy™ Platform comprises software packages, scalable microcontrollers, integrated development tools, and extensive eco-friendly systems. Renesas Synergy™ Platform provides developers of highly sophisticated embedded applications such as building automation an effective means to bring innovative new products to market quickly.

Reasons to Choose the Renesas Synergy™ Platform

Faster Development

Renesas takes care of the development of low level code up to the API. Customers can focus on innovating and differentiating their own end-products.

Lower Overall Costs

Renesas Synergy Software Package lets developers minimize risks and reduce overall costs, including maintenance.

Lower Barriers to Entry

Since there is no need to start from zero with initial costs and complex licensing fees, developers can focus on innovation.

General Structure of Renesas Synergy™ Platform

Renesas Synergy™ Platform is composed of a solution gallery, software, and hardware. The solution gallery features software, tools, kits, application projects, and services from Renesas and partner vendors that are compatible with Renesas Synergy™ Platform. At the core of the platform is the Synergy Software Package (SSP) and development environment (tools). Both are available at no additional charge to purchasers of Renesas Synergy™ microcontrollers.

Scalable and Compatible Microcontrollers

Renesas Synergy™ Family microcontrollers are based on Arm® Cortex®-M CPU cores and designed for scalability and the ability to reuse code between series. They offer connectivity functions and human-machine interface features facilitating easy implementation, alongside robust security and safety functions as well as numerous peripheral functions suitable for a variety of embedded systems.
Features of SSP: Application Frameworks and VSAs (Verified Software Add-ons)

### Application Frameworks

SSP has a rich set of Application Frameworks that provide a set of uniform Application Program Interfaces (APIs) that are useful for the development of target system. These APIs will free developers from worrying about the low-level software such as drivers, middleware or network stacks.

**Messaging framework:** High-level APIs for inter-thread communication and synchronization that give superior usability than traditional message queueing supported by real-time OS.

**GUIX™ interface framework:** APIs to leverage the performance advantage of Synergy Microcontroller graphic accelerators while using the GUIX runtime library.

**Wi-Fi framework:** APIs to easily integrate Wi-Fi connectivity solutions from various module and chipset providers into the user application.

**Capacitive touch sensing framework:** APIs to easily access the Capacitive touch sensing unit (CTSU). Also available is a Capacitive Touch Workbench GUIX™ interface framework:

- **Messaging framework:** APIs to easily integrate Wi-Fi connectivity solutions from various module and chipset providers into the user application.
- **Capacitive touch sensing framework:** APIs to easily access the Capacitive touch sensing unit (CTSU). Also available is a Capacitive Touch Workbench GUIX™ interface framework:

### VSAs (Verified Software Add-Ons)

Developers who adopt SSP for building automation applications can also utilize verified software add-ons (VSAs) from third-party partners to implement a variety of functions. VSAs are pre-tested by Renesas to be compatible with SSP.

**BACnet Stack:** BACnet stack compliant to CIA specifications. Available from CS Lab.

**Skkynet ETK:** Stack to connect device and cloud. Available from Skkynet.

**DALI 2.0 lighting control:** Stack compatible with the Digital Addressable Lighting Interface 2 (DALI-2) standard. Supplied by CS Lab.

**Medium One Cloud Agent:** Easily connect to cloud and access services. Available from Medium One.

### Product Example (PE), Application Example (AE)

Synergy Solutions are examples of actual products that adopt the platform (PE) or demonstrate a group of technologies that are implemented with the platform (AE). Following are solutions useful for BA.

**AE-CLOUD2**
- **Hardware kit for evaluating cloud connectivity**
- **Support for two cloud solutions (Synergy Enterprise Cloud Toolbox (SECT) and Renesas IoT Sandbox), enabling quick implementation of cloud connectivity**
- **Based on S5D9 Group MCU**
- **Many analog input functions suitable for a variety of sensor input types**

**AE-CAP1**
- **Capacitive Touch Evaluation and Tuning**
- **Based on S124 or S3A7 Group MCU**
- **Buttons, sliders, wheels**

Other Available Synergy Kits: SK-S7G2, PK-S5D9, TB-S5D5, TB-S3A1, TB-S3A6, TB-S3A3, DK-S7G2, DK-S3A7, DK-S128, DK-S124
The Synergy Platform provides technologies that support the applications demanded by the building automation segment. It makes it possible to quickly deliver optimized solutions to meet constantly changing technology needs such as performance, power efficiency, and design flexibility.

Synergy Platform Technology Matrix for the Building Automation Market

<table>
<thead>
<tr>
<th>Building Automation Subsegment</th>
<th>Motor Control Solutions</th>
<th>User Interface Solutions</th>
<th>Connectivity Solutions</th>
<th>Sensing Solutions</th>
<th>Synergy MCU Series*</th>
</tr>
</thead>
<tbody>
<tr>
<td>HVAC systems</td>
<td></td>
<td>&lt; PWM timer &lt; IAL direct access to timer functions [SSP] &lt; Safety functions &lt; A/D converter, D/A converter, comparator</td>
<td>&lt; Graphic LCD controller &lt; Capacitive touch sensing unit &lt; Capacitive touch solution</td>
<td>&lt; Wired connection interface &lt; Wi-Fi framework &lt; BACnet stack VSA &lt; Renesas RL78/G1D BLE chipset</td>
<td>S7 S5 S3</td>
</tr>
<tr>
<td>Fire and safety systems</td>
<td></td>
<td>&lt; Graphic LCD controller &lt; Segment LCD controller &lt; Graphic LCD interface &lt; Capacitive touch sensing unit &lt; Capacitive touch solution</td>
<td>&lt; Wired connection interface &lt; Wi-Fi framework &lt; BACnet stack VSA &lt; Renesas RL78/G1D BLE chipset</td>
<td>&lt; Temperature sensor &lt; Analog data collection framework &lt; A/D converter, D/A converter, PGA, comparator &lt; Digital sensor interface</td>
<td>S7 S5 S3</td>
</tr>
<tr>
<td>Building security systems</td>
<td></td>
<td>&lt; Graphic LCD controller &lt; Segment LCD controller &lt; Capacitive touch sensing unit &lt; Capacitive touch solution</td>
<td>&lt; Wi-Fi framework &lt; BACnet stack VSA &lt; Renesas RL78/G1D BLE chipset</td>
<td>&lt; Temperature sensor &lt; Analog data collection framework &lt; A/D converter, D/A converter, PGA, comparator &lt; Digital sensor interface</td>
<td>S7 S5 S3</td>
</tr>
<tr>
<td>Lighting systems</td>
<td></td>
<td>&lt; General-purpose I/O ports &lt; Capacitive touch sensing unit &lt; Capacitive touch solution</td>
<td>&lt; General-purpose I/O ports &lt; Serial interfaces (SPI, QSPI, I2C, UART) &lt; DALI communication interface &lt; DALI 2.0 lighting control VSA</td>
<td>&lt; Temperature sensor &lt; Analog data collection framework &lt; A/D converter, D/A converter, PGA, comparator &lt; Digital sensor interface</td>
<td>S7 S5 S3</td>
</tr>
</tbody>
</table>

* Refer to the block diagrams below for the recommended Synergy MCU Series for each subsegment.

1. **User Interface Solutions**
   - Graphic LCD, segment LCD control [MCU]
   - GUIX™ runtime library [SSP]
   - PE-HMI1 [PE]
   - Capacitive touch sensing unit [MCU]
   - Capacitive touch sensing framework [SSP]
   - Touch sensing workbench [SSP]

2. **Connectivity Solutions**
   - Wired connection: Single/dual Ethernet
   - USB, serial interfaces (SPI, QSPI, I2C, UART), SDIO
   - Wireless connection: Wi-Fi framework [SSP] for connection to various Wi-Fi devices and chipsets
   - BACnet protocol [VSA]
   - DALI 2.0 lighting control [VSA]
   - TLS/MQTT [SSP]

3. **Sensing Solutions**
   - Interfaces for data collection from analog sensors or digital sensors [MCU]
   - Op-amp, PGA, A/D converter, D/A converter, comparator [MCU]
   - Low-power operating mode for intermittent operation

4. **Motor Control Solutions**
   - High-precision timer, PGA, A/D converter, and D/A converter for motor control [MCU]
   - Direct access to MCU control registers for real-time control

5. **Embedded Security (Common Technology Across Subsegments)**
   - Encryption, security key generation and storage [MCU]
   - Security function library [SSP/MCU]

---

**Building Security System Solution Block Diagram**

- Synergy S7 or S5 MCU Series acts as the primary controller for the hub (main controller).
- Synergy S3 or S1 MCU Series acts as the controller for the nodes.
- Connectivity to the cloud via Ethernet or Wi-Fi.
- BLE connectivity between nodes and the hub.
Synergy S7 or S5 MCU Series acts as the primary controller for the hub (main controller).

Synergy S3 or S1 MCU Series acts as the controller for the nodes.

Connectivity to the cloud via Ethernet or Wi-Fi.

Synergy S7 or S5 MCU Series acts as primary controller for Zone Control.

Synergy S5 or S3 MCU Series for the Thermostat.

Synergy S1 MCU Series acts as the controller for the nodes.

Connectivity to the supervisory BAS system using BACnet.

Synergy S7 or S5 MCU Series acts as the primary controller for the control panel.

Synergy S3 or S1 MCU Series acts as the controller for the local sensing nodes.

Connectivity to the cloud via Ethernet or Wi-Fi.

BLE connectivity between nodes and the hub.
RECOMMENDED DEVICES FOR BUILDING AUTOMATION

RL78

The RL78 family is the new generation of power-efficient microcontrollers from Renesas. It enables customers to build compact and energy-efficient systems at lower cost.

### RL78 Family Portfolio

- **General Purpose**
  - Standard RL78/I12
  - Low Power RL78/I1B

- **Communications**
  - Standard RL78/I12
  - Low Power RL78/I1B

- **Motor**
  - Standard RL78/I12
  - Low Power RL78/I1B

- **LCD**
  - Standard RL78/I12
  - Low Power RL78/I1B

- **ASSP**
  - Standard RL78/I12
  - Low Power RL78/I1B

- **Automotive**
  - Standard RL78/I12
  - Low Power RL78/I1B

- **RL78/I1x Series**
  This series of microcontrollers provides functionality ideal for use in products for building systems and industrial applications. It is particularly well suited for applications involving sensing, energy control, measurement, and detection.

#### Main Features

- **Feature 1: Powerful analog functions**
  Integrated Δ∑ ADC, CMP, PGA, etc., for reduced total cost
- **Feature 2: Reduced power consumption**
  The most advanced low-power functionality in the RL78 Family
- **Feature 3: High-temperature tolerance**
  Operation at up to 125°C

<table>
<thead>
<tr>
<th>Feature</th>
<th>10bit SAR ADC</th>
<th>12bit SAR ADC</th>
<th>24bit Δ∑ ADC</th>
<th>DAC</th>
<th>Comparator</th>
<th>Temperature Sensor</th>
<th>Op-Amp (PGA)</th>
</tr>
</thead>
<tbody>
<tr>
<td>RL78/I1A</td>
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<td>RL78/I1B</td>
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<td>RL78/I1C</td>
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<td>RL78/I1D</td>
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<tr>
<td>RL78/I1E</td>
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</tbody>
</table>

*Note: Functions differ depending on the product.*
ASSP for LED Lighting Power Supplies

**RL78/I1A**

**Features**
- Basic peripheral functions for lighting power supplies
  - Timers for LED control and PFC control
  - Analog feedback functions (PGA, comparator)
  - Operation temperatures up to 105°C or 125°C
- Communication functions (DALI, PMBus, SMBus, DMX512, UART, I2C, CSI)

**Peripheral functions specifically for intelligent and highly efficient operation**
- Dithering function (0.98μs pseudo-resolution), soft start function, maximum frequency limit function, interleaved PFC, communication standby

**Main Applications**
- LED lighting
- Digital power supplies
- Illumination fixtures
- Laser printers
- Microwave ovens
- Vacuum cleaners
- Communication devices

ASSP for Power Meters

**RL78/I1B, I1C**

**Features**
- ΔΣ ADC with enhanced functionality for power meters
  - Implementation in hardware of functionality essential for measurement
  - Low power consumption during both metering operation and backup operation

- High-speed on-chip oscillator with ±0.05% accuracy
  - Implementation in a single-crystal system of precision needed for metering operation
  - Industry’s first hardware implementation of AES GCM mode for DLMS standard (I1C, I1C (512KB))

**Main Applications**
- Smart meters
- Eco-friendly meters

ASSP for Sensors and Detectors

**RL78/I1D**

**Features**
- Low power consumption for extended operation on battery power
  - Fast recovery from STOP mode in 3.4μs, and low 124μA operating current at 1MHz
  - Support for peripheral circuit operation bypassing the CPU (sensor activation, amplification, acquisition of A/D conversion results), determination of whether or not the CPU needs to be activated based on A/D conversion results

- On-chip integration of analog functions needed by sensors and detectors
  - General-purpose op-amp, 12-bit A/D converter, comparator

**Main Applications**
- Sensors, detectors
- Other crime prevention devices
- Battery-powered devices
- Sensor applications

ASSP for High-Precision Sensing

**RL78/I1E**

**Features**
- Analog functions for high-precision sensors
  - 24-bit ΔΣ A/D converter × 4 channels
  - 10-bit SAR-A/D converter ×10 channels
  - Configurable amplifier ×3 channel
  - 12-bit D/A converter ×1 channel
  - Sensor power supply ×1 channel

- Compact package, contributing to more compact sensor products
  - 4mm-square: 36-pin FBGA
  - 5mm-square: 32-pin VQFN
  - High-temperature tolerance
  - -40 to 125°C

**Main Applications**
- Measuring devices
- Sensor applications
- Vacuum cleaners
- Communication devices
PLC Modem IC

PLC is a technology that uses existing power lines as the communication medium. Using the power grid as a communication network makes it possible to build out systems cheaply and quickly. Either AC power lines or DC power lines can be employed as the communication medium. Renesas offers narrowband PLC modem IC products with integrated CPUs that implement high-performance DSP and support a variety of power line communication protocols. They employ orthogonal frequency-division multiplexing (OFDM) to deliver highly reliable, robust communication. Renesas PLC modem ICs support high data transfer speeds up to 1Mbps over long distances of a kilometer or more.

Product Selection Guide

Renesas offers two PLC modem IC products. Select the one that best matches your application and the scale of your network.

<table>
<thead>
<tr>
<th>Product</th>
<th>Features</th>
</tr>
</thead>
<tbody>
<tr>
<td>R9A06G037</td>
<td>This PLC modem IC complies with international power line communication standards (G3-PLC, PRIME, and Meters and More). Suitable for large-scale mesh networks with multi-hop support.</td>
</tr>
<tr>
<td>R9A06G061</td>
<td>This compact and powerful PLC modem IC is designed specifically for peer-to-peer (P2P) networks. It delivers high communication speeds up to 1Mbps.</td>
</tr>
</tbody>
</table>

Comparison of Product Features

<table>
<thead>
<tr>
<th>R9A06G037</th>
<th>R9A06G061</th>
</tr>
</thead>
<tbody>
<tr>
<td>Speed</td>
<td>Max. 280kbps</td>
</tr>
<tr>
<td>Communication distance</td>
<td>1km or more</td>
</tr>
<tr>
<td>Network type</td>
<td>Multi-hop (mesh or tree)</td>
</tr>
</tbody>
</table>

Recommended Renesas Devices

Block | Product Category | Recommended Product
--- | --- | ---
Control MCU | MCU | RX Family
Communication module | PLC modem IC | R9A06G037
| Line driver | ISL15102
| AC/DC regulator | RAA223011
| DC/DC regulator | ISL85412
| Photocoupler | RV1S2211A

RZ

All sorts of products that impact people’s lives in areas such as household appliances, industrial equipment, building management, power networks, and transport are gaining intelligent functions, and the cloud-connected “smart society” is fast becoming a reality. In addition to high-performance and low-power control, today’s microcontrollers are now expected to have sophisticated capabilities that would be difficult to implement with earlier microcontrollers, such as the ability to interoperate with IT networks and support human-machine interface functions. Embedded processors are making possible a new age we call “the Zenith of Renesas micro.” The RZ Family delivers features not available elsewhere and brings new value to customer’s applications.

RZ/V Series Application Fields
- IP camera
- Surveillance camera
- Entrance/exit gates
- Intercoms
- Video IP Phone
- POS terminal
- Barcode scanners

RZ/G Series Application Fields
- Centralized building management (HVAC)
- Security panels, signage
- Entrance/exit gates
- Elevator monitoring
- Intercoms, VOIP, Videoconferencing

RZ/A Series Application Fields
- White goods
- Barcode scanners
- Biometric authentication, face recognition
- Banknote detection
- Communication robots
- Intercoms
- Smart speakers

RZ/T Series Application Fields
- Industrial motors
- Industrial controller
- Robots
- AC Servo drivers

RZ/N Series Application Fields
- Entrance/exit gates
- Surveillance cameras
The RX Family is built around an advanced CPU core exclusive to Renesas. This 32-bit CPU core benefits from all the exclusive technology amassed by Renesas over the years and adds enhancements to boost responsiveness and improve power efficiency. It achieves small code size typical of 16-bit CPUs while delivering top-class 32-bit arithmetic operation performance and low power consumption. Many technologies built by Renesas are integrated into the RX Family. It aims to be the ultimate family of 32-bit microcontrollers with on-chip flash for the industrial, home appliance, and OA/ICT fields.

### ASSP for Inverter Control
**RX66T**

**Features**
- RXv3 Core 160 MHz operation (5.8 CoreMark/MHz), single-precision FPU
- 2.7 to 5.5 V operation
- Operating Temperature -40 to 105 °C
- Program Flash up to 1 MB, SRAM up to 128 KB
- Enhanced Analog

- 12-bit A/D Converter × 3 units , 12-bit D/A Converter × 2 channels
- 6-channel Comparators
- 6-channel Pseudo-Differential PGA
- 160 MHz PWM
- 4 channels for 3-phase complementary switching, 2 channels for 5-phase complementary switching, 10 channels for single-phase complementary switching

- 4-channel high-resolution PWM enables minimum 195 ps timing adjustment

**Main Applications**
- Industrial
- Office Automation
- Home appliances

### For Bluetooth & System Control
**RX23W**

**Features**
- RXv2 core 54MHz operation (4.33 CoreMark/MHz), single-precision FPU
- Operating voltage: 1.8V to 3.6V
- Operating temperature: -40°C to 85°C
- Program Flash up to 512KB, SRAM up to 64KB

- Built-in Bluetooth dedicated AES-CCM (128-bit) encryption circuit
- USB 2.0 Host/Function/OTG (one channel)
- Full speed (12Mbps), low speed (1.5Mbps), isochronous transfer
- BC (battery charger) support
- CAN (one channel)
- ISO11898-1 compliant CAN, up to 1Mbps transfer
- SD Host 1/f (on channel)
- SD memory/SDIO 1- or 4-bit SD bus support
- Capacitive Touch Sensing
- Self-capacitive method: Up to 12 keys supported in a 1-terminal 1-key configuration

**Main Applications**
- Bluetooth Low Energy Wireless
- Security

### For Touch Key
**RX671**

**Features for RX671**
- 120MHz RXv3 core (707 CoreMark, 48.8 CoreMark/mA), double-precision FPU, and register bank save function that speeds up interrupt response
- 2MB flash memory (60MHz read access, dual bank function), 384KB SRAM
- 48-pin to 176-pin package lineup including ultra-small 64-pin TFBGA (4.5mm × 4.5mm)
- Capacitive touch sensing unit and serial sound interface
- SD host interface, USB 2.0 full speed, CAN 2ch, and QSPI supporting XIP mode
- Encryption engine (AES, RSA, ECC, SHA, etc.), key management, access management circuit, flash memory protection

**Features for RX140**
- 12-bit A/D converter, 8-bit D/A converter, temperature sensor
- 32-bit general-purpose PWM timer, 16-bit general-purpose PWM timer, low power asynchronous general-purpose timer
- Real-Time Clock
- Security (AES encryption, true random number generator)
- Enhanced Safety functionality
- Pin and peripheral compatibility with RX130
- Diverse package lineup from 32 to 80-pin, including QFP and QFN options

**Main Applications**
- Home appliances
- Industrial
- Building automation
- Home automation
- Consumer
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